

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Present Application:**

Applicants : Sion C. Quinlan and Tim J. Bales      Attorney Docket No. : 30022/US/3  
Filed : Concurrently herewith      Customer No. : 27,076  
Title : SEMICONDUCTOR PACKAGE ASSEMBLY AND METHOD FOR ELECTRICALLY  
ISOLATING MODULES

**Prior Application:**

Examiner : Scott B. Geyer  
Art Unit : 2829  
Serial No. : 10/057,205

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**PRELIMINARY AMENDMENT**

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 14 of this paper.